DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby			•			•		
My residence, post office address and								
I believe I am the original, first and so listed below) of the subject matter whi	ole invo ch is cl	intor (if only one name is listed had and for which a patent is	below) or sought o	an original, f the invention	irst and joint inventor entitled:	(if plural names ar		
DIPHENYL ANTHRACEN EMPLOYING THE SAME					•	ENT DEVICE		
the specification of which is	attact	ed hereto unless the foll	lowing	box is che	cked:			
was filed on as United States Application Number or PCT International Application Number and was amended on (if applicable).								
I hereby state that I have reviewe amended by any amendment refere	hes 5	understand the contents of th	he abov	e-identified s	pecification, includ	ing the claims, a		
I acknowledge the duty to disclos Code of Federal Regulations § 1.5	e infor 6.	mation which is known by a	me to b	e material to	patentability as de	fined in Title 37		
I hereby claim foreign priority application(s) for patent or invente one country other than the United inventor's certificate, or PCT Integlaimed: PRIOR FOREIGN APPLIC	benefit or's ce I State mation	ts under Title 35. United 3 trificate, or § 365(a) of an s, listed below and have als hal application having a filing	States C y PCT so identi g date b	Code, § 119 International fied below a refore that of	(a)-(d) or § 365(b) application which (ny foreign application on) of any foreign designated at least tion for patent of which priority is		
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NUMBER		COUNTRY	DAY/M		TH/YEAR FILED	PRIORITY CLAIMED		
2003-49		Republic of Korea		02/Ja	nuary/2003	Yes		
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I hereby claim the benefit under Title 3	5. Unit	ed States Code § 119(c) of any L	Jnited St	ates provisions	l application(s) listed	below.		
APPLICATION NO.			FILING DATE					
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hereby claim the benefit under Title international application designating the s not disclosed in the prior United States Code, § 112, I acknowledge the Tode of Federal Regulations § 1 international filing date of this application.	e 35, United es or F e duty 56 wh	United States Code, § 120 of a States, listed below and, insoft of Titernational application in to disclose information which is ich became available between the	any Un or as the the man known h ne filing	ited States ap subject matter for provided by me to be madate of the pr	plication(s), or \$ 3 of each of the claim, y the first paragraph aterial to patentability for application and the	65(c) of any PCT of this application of Title 35, United as defined in Title national or PCT		
APPLICATION SERIAL NO.		FILING DATE		STATUS: PATENTED, PENDING, ABANDONED				
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I hereby appoint as my attorneys, with full powers of substitution and revocation, to prosecute this application and transact all business in the Patent and Trademark Office connected therewith: Bugene M. Lee, Reg. No. 32,039; Richard A. Steba, Reg. No. 43,162.

Address all correspondence to Eugene M. Lee, LEE & STERBA, P.C., 1101 Wilson Boulevard, Suite 2000, Arlington, Virginia 22209. Address all telephone communications to Eugene M. Lee at (703) 525-0978.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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Pull Name of Fourth Inventor	Signature of This	rd Inventor	Date
Residence Address		Country of Citizensh	İ.
Post Office Address			
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